Key Features

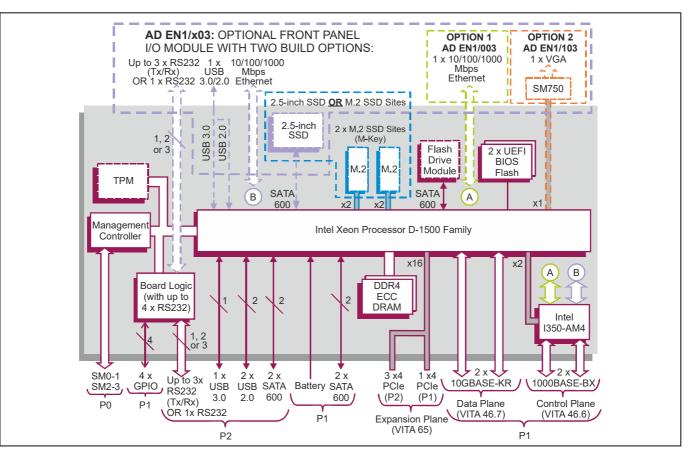
(OpenVPX)

VPX

TR G4x/msd is optimized for Size, Weight and Power (SWaP) rugged server applications which need excellent processing, memory and storage capabilities. Multi-processor systems can easily be constructed using the built-in Gigabit and 10 Gigabit Ethernet ports. TR G4x/msd is targeted towards long life-cycle rugged server applications across a range of military, aerospace, transportation and test markets.

- Intel[®] Xeon[®] Processor D-1500 Family:
 > 8-core, 12-core or 16-core processing options
- Up 64 Gbytes DDR4 memory for server grade applications
- Direct attached storage options including:
 - → Flash Drive Module
- → up to two M.2 modules or a 2.5-inch drive
- 10 Gigabit and Gigabit Ethernet connectivity
- PCI Express[®] connections for point to point expansion
- Long life-cycle support





CONCURRENT CONCURRENT

Concurrent Technologies Plc

Concurrent Technologies Inc.

4 Gilberd Court, Colchester, Essex, CO4 9WN, UK Tel: +44 (0)1206 752626 Fax: +44 (0)1206 751116 400 West Cummings Park, Suite 1300, Woburn, MA 01801, USA Tel: (781) 933 5900 Fax: (781) 933 5911 email:info@gocct.com http://www.gocct.com



Ehlbeek 15a 30938 Burgwedel fon 05139-9980-0 fax 05139-9980-49

www.powerbridge.de info@powerbridge.de TR G4x/msd N, E - Series

Please contact your local Concurrent Technologies sales office for further details on board build options and accessories.

VPX Embedded Computer Board

- air-cooled 3U VPX computing board utilizing the Intel[®] Xeon[®] processor D-1500 family:
 optional Rear Transition Module (RTM)
- OpenVPX[™] profiles supporting 10GBASE-KR on Data Plane:
 - → MOD3-PAY-2F4F2U-16.2.10-8
 - → MOD3-PAY-2F1F2U-16.2.1-8

Central Processor

- 8-core Intel[®] Xeon[®] processor D-1539:
- → 12 Mbytes Cache, 1.6 GHz
- 8-core Intel[®] Xeon[®] processor D-1548: → 12 Mbytes Cache, 2.0 GHz
- 12-core Intel[®] Xeon[®] processor D-1559:
- → 18 Mbytes Cache, 1.5 GHz
- 16-core Intel[®] Xeon[®] processor D-1577:
 > 24 Mbytes Cache, 1.3 GHz
- Intel[®] Advanced Vector Extensions 2
- Intel[®] AES New Instructions
- server class processing cores in a System-on-a-
- Chip package

DRAM

- up to 64 Gbytes soldered DDR4 ECC DRAM:
 - single bit error correction and dual bit error detection
 - → peak bandwidth of 34 Gbytes/s
 - dual channel architecture
- accessible from processor or VPX Expansion Plane

Serial Ports

- up to 4 x user selectable RS232 serial ports
- the first RS232 port via P2 supports either:
 - → Tx/Rx CTS/RTS, DTR/DSR
 → or Tx/Rx
- the second RS232 port via the Front I/O Module supports either:
 - → Tx/Rx, CTS/RTS, DTR/DSR, DCD
 - → or Tx/Rx
- when enabled, the third and fourth RS232 (Tx/Rx) ports are either individually or both switched to the P2 connector or the Front I/O Module (replacing the first and second ports' modem signals)
- 16550 compatible UARTs

Mass Storage Interfaces

- 5 x SATA600 interfaces:
 - → 2 x SATA via P1
 - → 2 x SATA via P2
 - → 1 x SATA routed to an optional on-board Flash Drive Module for operating system and application storage
 - → 1 x SATA routed to an optional on-board 2.5-inch solid-state disk drive (subject to the optional Front I/O Module fitted <u>and</u> subject to the optional M.2 SSD sites not fitted)
- option for 2 x M.2 SSD sites on-board supporting:
 - → 2242, 2260 and 2280 format modules
 - → x2 PCIe interface (M-key)
 - → NVM Express[®] (NVMeTM) logical device interface
 - → RAID 0, 1, 5 and 10 modes
 - subject to the optional on-board 2.5-inch solidstate disk drive not fitted

Other Peripheral Interfaces

- PC RTC, long duration timer, watchdog timer
- up to 4 x USB ports:
 - → 2 x USB 2.0 ports via P2
 - → 1 x USB 3.0 port via P2
 - → 1 x USB 3.0/2.0 port via the Front I/O Module
- 4 x GPIO signals via P1

Graphics Interface

- an on-board graphics interface is not provided
- if graphics interface required, either:
 - → use the optional Front I/O Module (with VGA)
 - or use an Expansion Plane PCI Express port via backplane to a graphics processor module

Optional Front I/O Module

- the optional Front I/O Module supports:
 1 x 10/100/1000 Mbps Ethernet port via an RJ45
 - → 1 x USB 3.0 and 1 x USB 2.0 ports via a USB Type-A connector
 - → up to 3 x RS232 (Tx/Rx) ports via an RJ45 or 1 x RS232 full modem via RJ45, user selectable
- build option for either:
 - → 1 x 10/100/1000 Mbps Ethernet port via an RJ45
 - → or 1 x VGA graphics interface supporting up to 1920 x 1080 @ 60Hz
- module is only available for use with TR G4x/msd air-cooled boards (N-Series and E-Series):
 - → fits into the board's front panel aperture

see datasheet's block diagram on front page

VPX Control Plane, One Gigabit Ethernet

- VPX Control Plane supports 2 x 1000 Mbps IEEE802.3z SerDes (1000BASE-BX) ports (VITA 46.6):
 - supports IEEE 1588 "Deterministic Network Timing" (contact sales office for supported operating systems)

VPX Data Plane, Ten Gigabit Ethernet

 VPX Data Plane interface provided by 2 x 10 Gigabit Ethernet interfaces (VITA 46.7):
 > supports 10GBASE-KR

VPX Expansion Plane, PCI Express

- configurable PCI Express® (PCIe®) VPX Expansion
 Diago interfere (UTA SE) supported
 - Plane interface (VITA 65) supports:
 - → 1 x4 PCle port via P1 connector
 - → 3 x4 PCIe ports via P2 connector
 - → the 16 lanes can be configured as 4 x4 ports, 2 x8 ports or 1 x16 port

compatible with OpenVPX module profiles

- PCle interface supports Gen 1, Gen 2 and Gen 3
 supports a Non-Transparent Bridge (NTB) port for multi-processing configurations
- 4 channel DMA engine for fast data block moves
- ports can be configured by the VPX Switch Configuration Tool, see separate datasheet

System Management

- IPMI via SM0-1 and SM2-3:
 - → CPU temperature and voltage monitor accessed via System Management interface

Specification

Baseboard Management Controller (BMC)

Optional Board Security Packages

- Trusted Platform Module (TPM):
- → compliant to TCG v1.2
- proprietary hardware/software board security

Optional Built-In Test (BIT) Support

- Power-on BIT, Initiated BIT, Continuous BIT
- Software Support
- supports Linux[®] and Windows[®]

Firmware Support

- UEFI boot firmware (BIOS):
- → UEFI 2.4 support
- → EDK II support

for redundancy

rating of UL94V-0

→ +5V @ 7.0A

operating temperature:

operating altitude:

relative humidity:

Electrical Specification

(2.0 GHz) with 32 Gbytes DRAM:

Environmental Specification

→ -25°C to +70°C (E-Series)

non-operating temperature:

→ +3.3V @ 1.2A; +3.3V AUX @ 0.3A

→ VITA 47 Class C1, -40°C to +85°C

→ 0 to 15,000 feet (0 to 4,572 meters)

→ 5% to 95%, non-condensing

VPX-REDI (RCx-Series) version:

Mechanical Specification

3U VPX form-factor (VITA 46.0)

slot width 1.0 inch air-cooled

operating mechanical:

(IEEE 1101.10 as per VITA 46.0)

→ shock - VITA 47 Class OS1, 20g

→ random vibration - 0.002g²/Hz

→ see TR G4x/3sd-RCx datasheet

3.9 inches x 6.3 inches (100mm x 160mm)

connectors to VITA 46.0 for P0, P1 and P2

Datasheet Code 1787/0317 © Concurrent Technologies 2017

Safety

→ includes Compatibility Support Module

16 Mbytes of BIOS Flash EEPROM, dual devices

PCB (PWB) manufactured with flammability

typical current consumption for 8-core processor

→ VITA 47 Class AC1, 0°C to +55°C (N-Series)

extended operating temperature (selected CPU):

option for rugged conduction-cooled (VITA 48.2)

- support for Serial Over LAN (SOL)
- LAN boot firmware included Non-Volatile Memory